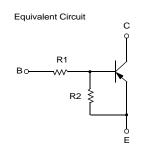


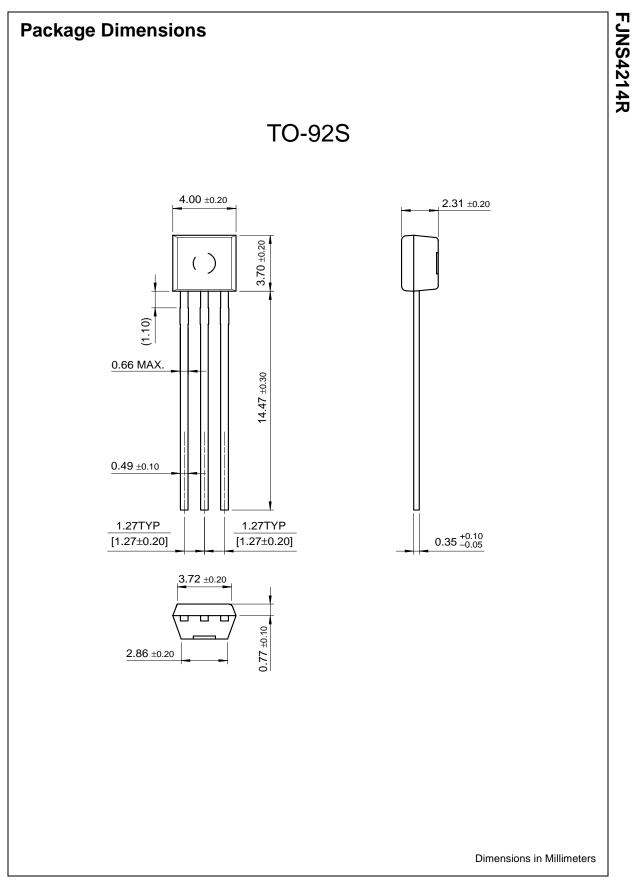
Symbol	Parameter	Value	Unite
ADSOIUI	e Maximum Kalings	a=25°C unless otherwis	se noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	-50	V
V <sub>CEO</sub>	Collector-Emitter Voltage	-50	V
V <sub>EBO</sub>	Emitter-Base Voltage	-10	V
Ι <sub>C</sub>	Collector Current	-100	mA
P <sub>C</sub>	Collector Power Dissipation	300	mW
TJ	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	-55 ~ 150	°C



# **Electrical Characteristics** $T_a=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	I <sub>C</sub> = -10μΑ, I <sub>E</sub> =0	-50			V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = -100μA, I <sub>B</sub> =0	-50			V
I <sub>CBO</sub>	Collector Cutoff Current	V <sub>CB</sub> = -40V, I <sub>E</sub> =0			-0.1	μΑ
h <sub>FE</sub>	DC Current Gain	V <sub>CE</sub> = -5V, I <sub>C</sub> = -5mA	68			
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> = -10mA, I <sub>B</sub> = -0.5mA			-0.3	V
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> = -10V, I <sub>C</sub> =-5mA		200		MHz
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> = -10V, I <sub>E</sub> =0 f=1.0MHz		5.5		pF
V <sub>I</sub> (off)	Input Off Voltage	V <sub>CE</sub> = -5V, I <sub>C</sub> = -100μA	-0.5			V
V <sub>l</sub> (on)	Input On Voltage	V <sub>CE</sub> = -0.2V, I <sub>C</sub> = -5mA			-1.3	V
R <sub>1</sub>	Input Resistor		3.2	4.7	6.2	KΩ
$R_1/R_2$	Resistor Ratio		0.09	0.1	0.11	



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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

### **PRODUCT STATUS DEFINITIONS**

#### **Definition of Terms**

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